SN74CBT16213 24-BIT FET BUS-EXCHANGE SWITCH

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- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and 300-mil Shrink Small-Outline (DL) Packages

description

The SN74CBT16213 provides 24 bits of high-speed TTL-compatible bus switching or exchanging. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device operates as a 24-bit bus switch or a 12-bit bus exchanger that provides data exchanging between the four signal ports via the data-select (S0–S2) terminals.

The SN74CBT16213 is characterized for operation from -40 °C to 85 °C.

DGG, DGV, OR DL PACKAGE (TOP VIEW)

1		U		1
so [1	\cup	56] S1
1A1 🛚	2		55] S2
1A2 🛚	3		54] 1B1
2A1 🛚	4		53	1B2
2A2 🛚	5		52	2B1
3A1 🛚	6		51	2B2
3A2 🛚	7		50	P ~
GND [8		49	P
4A1	9			3B2
4A2	10		47	4B1
5A1	11		46	4B2
5A2	12		45	5B1
6A1	13		44	F ~
6A2 🛚	14		43	
7A1 🛚	15		42	6B2
7A2 🛚	16		41	7B1
v _{cc} [17		40	7B2
8A1	18		39	8B1
GND [19		38	GND
8A2	20		37	8B2
9A1	21		36	9B1
9A2	22		35	9B2
10A1 🛚	23		34	10B1
10A2	24		33	10B2
11A1 🏻	25		32	11B1
11A2	26		31	11B2
12A1 🛚	27		30	12B1
12A2 🛚	28		29	12B2

FUNCTION TABLE

	INPUTS		INPUTS/OUTPUTS		FUNCTION	
S2	S1	S0	A1	A2	FUNCTION	
L	L	L	Z	Z	Disconnect	
L	L	Н	B1	Z	A1 port = B1 port	
L	Н	L	B2	Z	A1 port = B2 port	
L	Н	Н	Z	B1	A2 port = B1 port	
Н	L	L	Z	B2	A2 port = B2 port	
Н	L	Н	A2 and B2	A1 and B2	A1 port = A2 port = B2 port	
Н	Н	L	B1	B2	A1 port = B1 port A2 port = B2 port	
Н	Н	Н	B2	B1	A1 port = B2 port A2 port = B1 port	

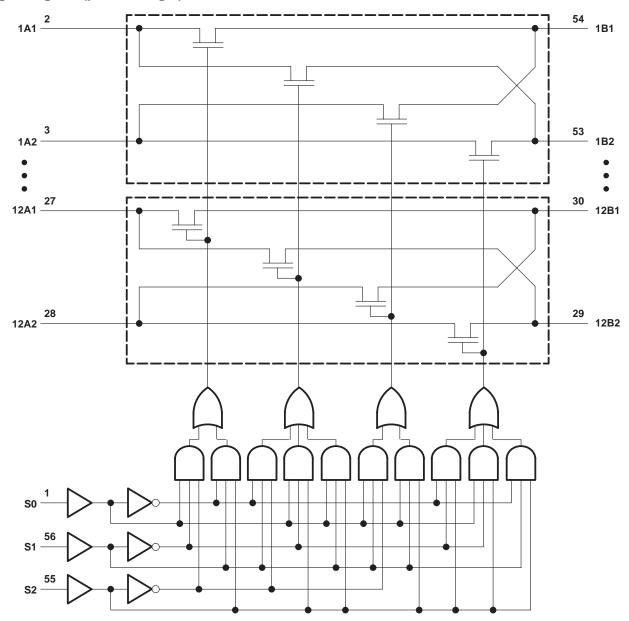


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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}		
Input voltage range, V _I (see Note 1)		–0.5 V to 7 V
Continuous channel current		128 mA
Input clamp current, I_{IK} ($V_I < 0$)		–50 mA
Package thermal impedance, θ _{JA} (see Note 2):		
•	DGV package	86°C/W
	DL package	74°C/W
Storage temperature range, Teta		65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
Vcc	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
VIL	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP‡	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA				-1.2	V	
		$V_{CC} = 0$,	V _I = 5.5 V				10		
l ₁		V _{CC} = 5.5 V,	$V_I = 5.5 \text{ V or GND}$				±1	μΑ	
ICC		$V_{CC} = 5.5 \text{ V},$	I _O = 0,	$V_I = V_{CC}$ or GND			3	μΑ	
∆ICC§	Control inputs	$V_{CC} = 5.5 \text{ V},$	One input at 3.4 V,	Other inputs at V _{CC} or GND			2.5	mA	
Ci	Control inputs	$V_I = 3 V \text{ or } 0$				4.5		pF	
C. (2)	B port	Va - 2 V or 0	S0 S4 or S2 - Voc			8.5		pF	
C _{io(OFF)}	A port	$V_{O} = 3 \text{ V or } 0,$ S0, S1, or S2 = V_{CC}		;		8			
	A to B or B to A	$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$	V _I = 2.4 V,	I _I = 15 mA		14	20		
		• • • • • • • • • • • • • • • • • • •	V _I = 0	I _I = 64 mA		5	7		
r _{on} ¶				I _I = 30 mA		5	7		
			V _I = 2.4 V,	I _I = 15 mA		8	15	Ω	
	A1 to A2	$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$	V _I = 2.4 V,	I _I = 15 mA		22	30	22	
		$V_{CC} = 4.5 \text{ V}$ $V_{I} = 0$ $V_{I} = 2.4 \text{ V},$	V _I = 0	I _I = 64 mA		10	14]	
				I _I = 30 mA		10	14		
			V _I = 2.4 V,	I _I = 15 mA		16	22		

[‡] All typical values are at $V_{CC} = 5 \text{ V}$ (unless otherwise noted), $T_A = 25^{\circ}\text{C}$.

[¶]Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51.

[§] This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

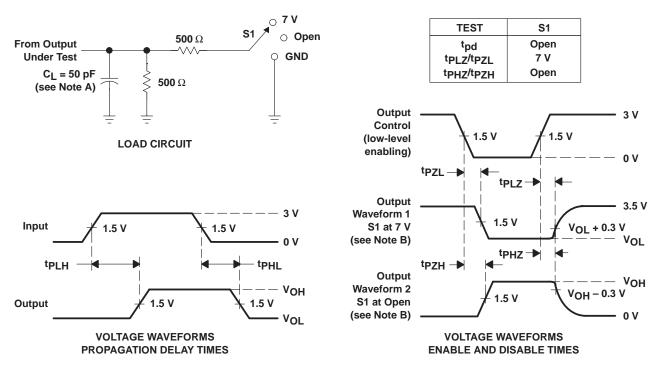
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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4 V	V _{CC} = 5 V ± 0.5 V		UNIT
	(INFOT)		MIN MAX	MIN	MAX	
. +	A or B	B or A	0.35		0.25	ne
t _{pd} T	A1	A2	0.5		0.5	ns
t _{en}	S	A or B	12.4	3.2	11.1	ns
^t dis	S	A or B	12.4	2.3	11.9	ns
t _{en}	S0	A2 and B2	11.5	4	10.9	ns
^t dis	S0	A2 and B2	12.8	5.7	12	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_{\Gamma} \leq$ 2.5 ns, $t_{\Gamma} \leq$ 2.5 ns,
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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